

### **Experienced**

COSINC has expert staff available to train and assist users in their projects. Our staff can be involved as collaborators and/or co-PIs on research proposals. COSINC is also part of RAIN, an National Science Foundation-funded remote training network.

# **Open access**

COSINC offers 24/7 open access to all our facilities after training on processes and equipment by our staff. This approach encourages users from diverse academic disciplines to use the facilities. In fact, COSINC offers a common platform for the convergence of multiple scientific and engineering disciplines and enables innovations in a wide range of areas, from electronics, photonics and quantum science to biomedical, pharmaceutical and nanomedicine.

The COSINC facility provides critical support for my research into the physical properties and rheology of naturally deformed rocks and minerals. Specifically, electron backscatter diffraction (EBSD) analysis is one of the back-bone tools utilized in investigations. COSINC provides the only EBSD capability at the University of Colorado."

- Associate Professor Kevin Mahan, Geological Sciences at CU Boulder

# **Developing hands-on skills and experience**

COSINC provides hands-on training on instrumentation to professional researchers, faculty and graduate and undergraduate students. Our aim is to empower all researchers to pursue diverse career and research goals, while also advancing fundamental and technical knowledge in the area of materials characterization techniques, micro- and nano-fabrication technologies.

# **Material Characterization Facility equipment**

- » Field-Emission Scanning Electron Microscopy (FESEM, JEOL JSM-7401F)
- » Focused Ion Beam (FIB)-Dual Beam (FEI Nova 600 Nanolab), with Electron Backscatter Diffraction (EBDS)
- » Scanning Electron Microscopy (SEM, Hitachi SU3500), with E-Beam lithography and EDS capability
- » Atomic Force Microscopy (AFM)
- » Scanning Tunneling Microscopy (STM)
- » X-ray Photoelectron Spectroscopy (XPS)
- » Low Energy Ion Scattering (LEIS)
- » X-ray Diffraction (XRD)

#### **ISO 5 Cleanroom equipment**

- » Laser Writer (Heidelberg DWL 66FS)
- » PlasmaTherm ICP and RIE Etchers
- » Thin-film deposition (Thermal, EBeam and Sputter)
- » Mask Aligners (Karl Suss MJB3)

